**KEY PARAMETERS** 

I<sub>F(AV)</sub>

I<sub>FSM</sub>

4500V

3230A

20000A

1800µC 7.0us



# **DSF21545SV**

# **FAST RECOVERY DIODE**

#### **APPLICATIONS**

■ The DSF21545SV is a purpose designed freewheel diode to complement the DG858BW GTO in inverter circuits, using energy recovery snubbers.

### **FEATURES**

- The DSF21545SV is designed for fast turn-on thus minimising reverse current through the GTO.
- Low recovered charge for low losses.
- DSF21545SV is housed in a similar outline to that of the DG858BW therefore offering complete mechanical compatibility for parallel and series clamping.

#### **VOLTAGE RATINGS**

Type Number	Repetitive Peak Reverse Voltage V	Conditions
DSF21545SV45	4500	$V_{RSM} = V_{RRM} + 100V$

Lower voltage grades available.

Outline type code: V. Turn to page 8 for further information.

#### **CURRENT RATINGS**

Symbol	Parameter	Conditions	Max.	Units			
Double Side Cooled							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, T <sub>case</sub> = 65°C	3230	Α			
I <sub>F(RMS)</sub>	RMS value	$T_{case} = 65^{\circ}C$	5080	А			
I <sub>F</sub>	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	4680	Α			
Single Side Cooled (Anode side)							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, T <sub>case</sub> = 65°C	2070	А			
I <sub>F(RMS)</sub>	RMS value	$T_{case} = 65^{\circ}C$	3255	А			
I <sub>F</sub>	Continuous (direct) forward current	T <sub>case</sub> = 65°C	2875	Α			

# **DSF21545SV**

# **SURGE RATINGS**

Symbol	Parameter	Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10ms half sine; with 09/ V T = 150°C	20	kA
l²t	I <sup>2</sup> t for fusing	10ms half sine; with 0% $V_{RRM}$ , $T_j = 150^{\circ}C$	2.0 x 10 <sup>6</sup>	A <sup>2</sup> s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10mg half aings with E00/ V T 1E00C	16	kA
l²t	I <sup>2</sup> t for fusing	-10ms half sine; with 50% $V_{RRM}$ , $T_j = 150$ °C	1.28 x 10 <sup>6</sup>	A <sup>2</sup> s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10ms half sine; with 100% V T = 150%	-	kA
l²t	I <sup>2</sup> t for fusing	10ms half sine; with 100% $V_{RRM}$ , $T_j = 150$ °C	-	A <sup>2</sup> s

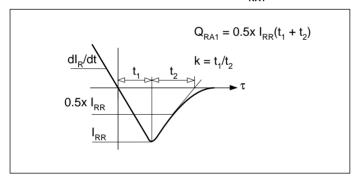
# THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance - junction to case	Double side cooled	dc	-	0.0075	°C/W
		Single side cooled	Anode dc	-	0.015	°C/W
			Cathode dc	-	0.015	°C/W
R <sub>th(c-h)</sub>	Thermal resistance - case to heatsink	Clamping force 35.0kN with mounting compound	Double side	-	0.002	°C/W
			Single side	-	0.004	°C/W
T <sub>vj</sub>	Virtual junction temperature	On-state (conducting)		-	150	°C
T <sub>stg</sub>	Storage temperature range			-55	150	°C
-	Clamping force			34	48	kN

# **CHARACTERISTICS**

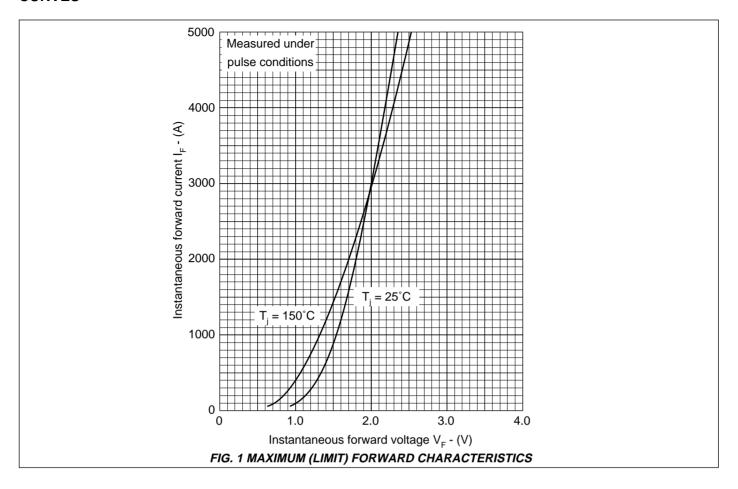
Symbol	Parameter	Conditions	Тур.	Max.	Units
V <sub>FM</sub>	Forward voltage	At 3000A peak, T <sub>case</sub> = 25°C	-	2.0	V
I <sub>RRM</sub>	Peak reverse current	At V <sub>RRM</sub> , T <sub>case</sub> = 150°C	-	150	mA
t <sub>rr</sub>	Reverse recovery time		7.0	-	μs
Q <sub>RA1</sub>	Recovered charge (50% chord)	$I_F = 1000A$ , $di_{RR}/dt = 100A/\mu s$	-	1800	μС
I <sub>RM</sub>	Reverse recovery current	$T_{case} = 150^{\circ}C, V_{R} = 100V$	-	500	Α
К	Soft factor		2	-	-
V <sub>TO</sub>	Threshold voltage	At T <sub>vj</sub> = 150°C	-	1.25	V
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 150°C	-	0.25	mΩ
V <sub>FRM</sub>	Forward recovery voltage	di/dt = 1000A/μs, T <sub>j</sub> = 125°C	-	75	V

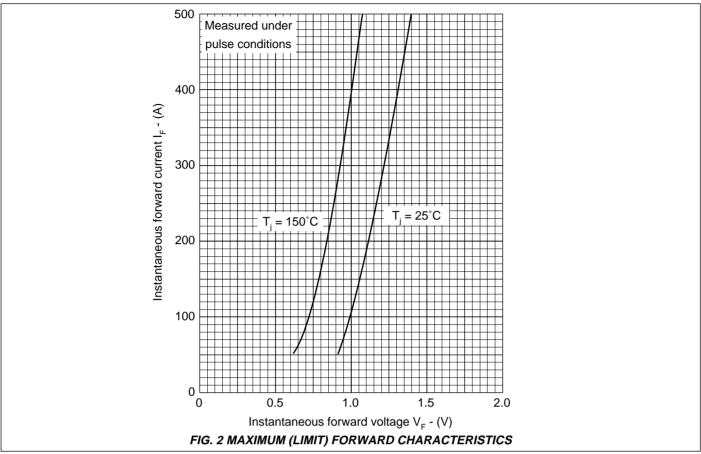
# DEFINITION OF K FACTOR AND $\boldsymbol{Q}_{\text{RA1}}$

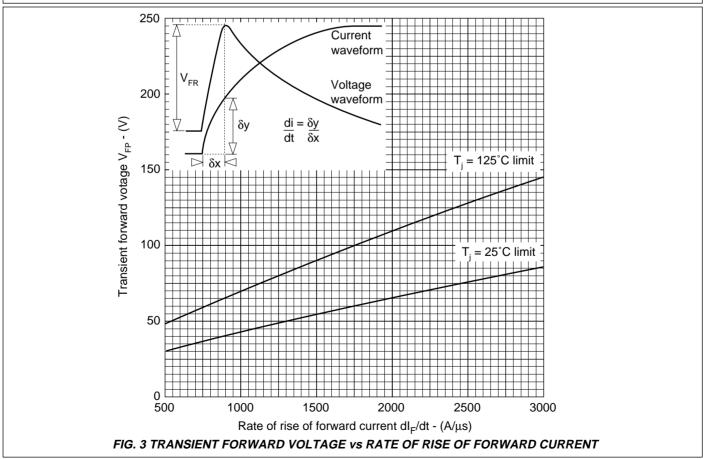


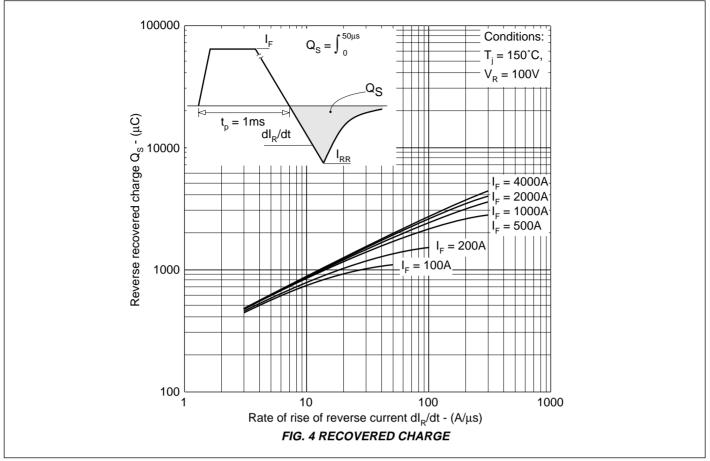
### **DSF21545SV**

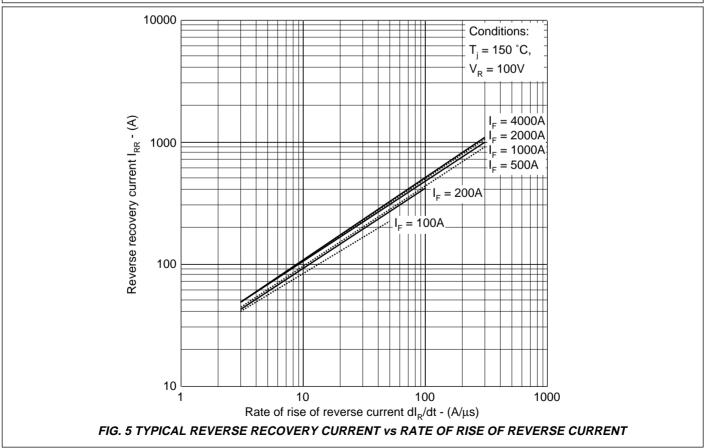
# **CURVES**

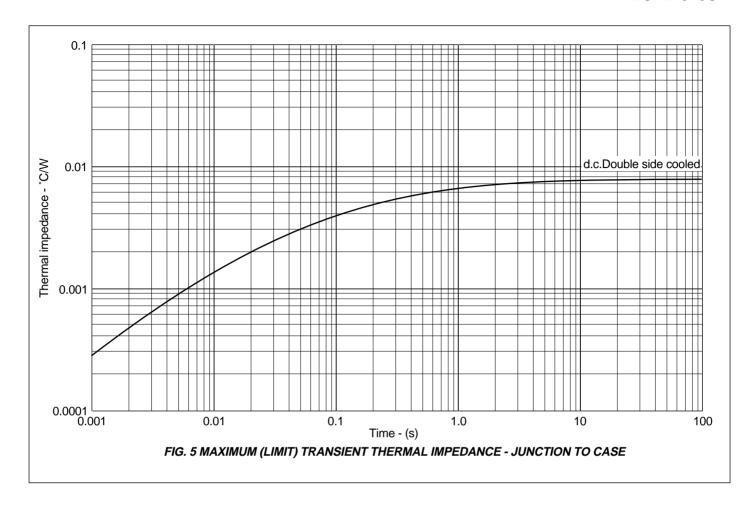






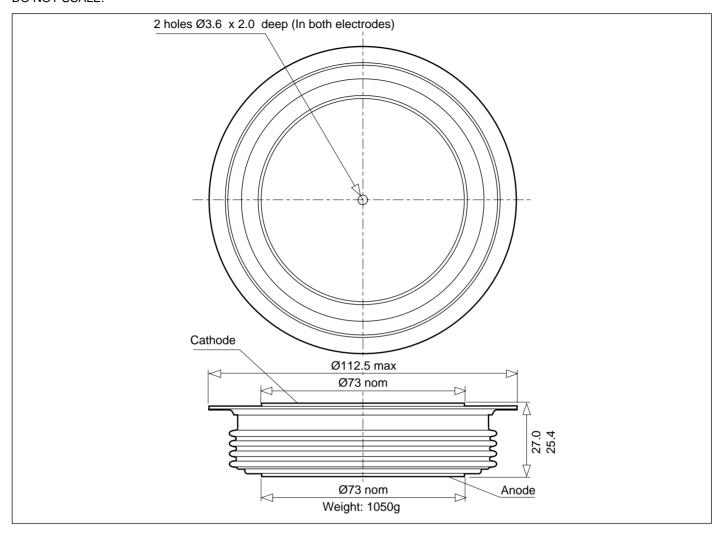






#### **PACKAGE DETAILS - V**

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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